

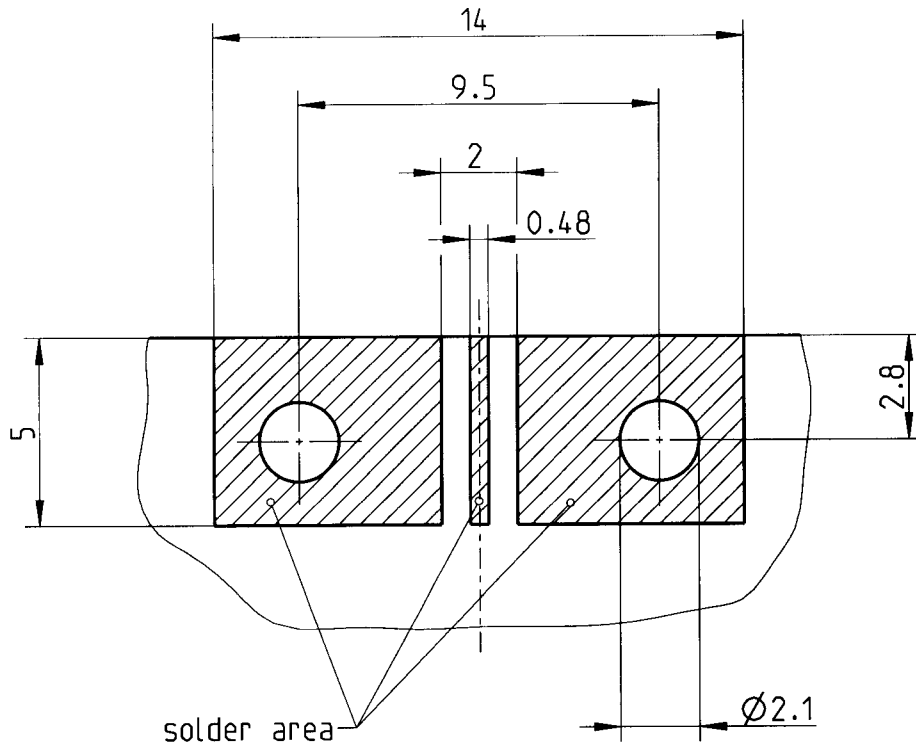
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Formzahl: TC-FB-05-2K-A-Enzeteil  
Datei: A4-LENZTEIL-ED9-FRM  
Version: 1.0

ISO-Projektion  
Methode E

Leiterplatten-Layout  
PCB layout  
B 208



A wide variety of transmissionline topologies and pcb-parameters like permittivity, substrate thickness, and board-stackup are applied by customers. These parameters have a strong impact on the high frequency performance of the mounted connector.

Please note, that the given layout is not optimised to fit all of the possible board configurations regarding RF-performance, it represents a recommendation for optimum solderability of the connector.

In order to guarantee optimum high frequency properties of the connector, an RF-analysis of the connector to board transition is recommended.

<b>Rosenberger</b> Hochfrequenztechnik 84526 Tittmoning Pro/ENGINEER		general tolerance <b>ISO 2768 RN 006-01</b> m-H dimensions <0,5 and symmetry		scale: 5:1	weight(g): surface(mm²):	
		material:		title:		
		date drawn 16.11.2005 check. 30.11.05 appr. 21/12/05	name A_Nobis	<b>Leiterplatten-Layout PCB layout</b>		
		dimensioning incl. finish				
a00	05-0615	A_Nobis	16.11.2005	distribu- tion to:	FE AZ QSM RMT . X . . . .	of: 1
rev. change-no		name date		remarks:		

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